

# TimeCesium 4400

## Cesium Primary Reference Source



### **Key Features**

- State of the art Cesium III beam tube technology
- Autonomous Stratum 1 primary reference source
- No antenna installation required
- Front access ETSI shelf
- DS1, E1, 2048 kHz G.703/13, 10 MHz, 5 MHz, 1.544 MHz and composite clock outputs

### **Key Benefits**

- Maintenance-free (8-year warranty on Cesium tube)
- Plug & play in less than 45 minutes of installation
- Lowers the overall operation, administration, maintenance and provisioning costs
- Enhances network performance and provides total control of your network synchronization source
- Prevents up-stream clock errors from propagating across the network

The TimeCesium® 4400 is an autonomous Primary Reference Source based on the Cesium III technology from Microsemi®. It is designed for telecom network operators to generate superior and highly reliable Stratum I synchronization signals for advanced network services.

### Plug & Play In Less Than 45 Minutes

The TimeCesium 4400's architecture uses the latest digital technology to provide superior performance and maintenance-free operation. The TimeCesium 4400 is easy to install and is fully operational in less than 45 minutes. Its plug & play architecture provides highly reliable operation over the lifetime of the system.

### **Network Applications**

The TimeCesium 4400 is used to equip core network offices with Stratum 1 synchronization.

The deployment of TimeCesium 4400 sources across the network provides the following benefits:

- Flattens the sync distribution hierarchy
- Lowers the overall OAM&P (Operation, Administration, Maintenance & Provisioning) costs
- Reduces the number of network recovery clocks (TSG/SSU) operating in tandem
- Minimizes pointer adjustments caused by "frequency errors" in the SONET/SDH payload
- Prevents up-stream network clock errors from propagating across the network
- Enhances overall network performance
- Provides total control of your network synchronization source

### **Standards Compliance**

The TimeCesium 4400 meets industry standards, including ITU-T, ETSI, ANSI, Telcordia, NEBS, and CE/AS.

### TimeCesium 4400

### **Specifications**

### **PERFORMANCE**

• Accuracy (over environment): ≤ ± 1 x 10<sup>-12</sup>

#### **STABILITY**

· Averaging time:

1 s 1.2 x 10<sup>-11</sup>
10 s 8.5 x 10<sup>-12</sup>
100 s 2.7 x 10<sup>-12</sup>
1,000 s 8.5 x 10<sup>-13</sup>
10,000 s 2.7 x 10<sup>-13</sup>
• Warm-up time (typical): 30 minutes

#### OUTPUTS

Telecom signals:
 Two framed or unframed

• Framed (AMI)

1544 kbps: ANSI T1.102 DS1 selectable framing:

SF(D4) or ESF, with Stratum 1 Sync Status

Message (SSM)

Format: Framed all ones, B8ZS

2048 kbps ITU-T Rec.G.703/9 (E1) with G.704

framing and with Stratum 1 Sync Status

Message (SSM)

Format: Framed all ones, HDB3

• Unframed:

 1544 kHz
 G.703/13

 2048 kHz
 G.703/13

 Composite Clock
 G.703/4

• Connectors: DB9 for balanced signal

CC, 133Ω T1, 100Ω E1, 120Ω

BNC for unbalanced signals,  $75\Omega\,$ 

• Sinusoidal signals: 1 at 5 MHz, 10 MHz,

0.5 V rms/50Ω, BNC

#### **GENERAL**

Power requirements: Dual redundant DC inputs

• Operating voltage: —48 V DC nominal (–36 to –62 V DC)

Power

Operating: 40 W Warm-up: 55 W

• Interface connections

External DC inputs, A and B: #6 screw terminal block RS232: 9 pin male D-connector Chassis ground, A and B: #6 screw terminal block Alarm – Critical and Minor: #6 screw terminal block Fuses External DC Input 2 A,

250 V, slow acting

• Dimensions

 Width:
 18.2" [46.2 cm]

 Depth:
 10.2" [25.7 cm]

 Height:
 10.5" [26.67 cm]

 Weight:
 36.5 lb [16.6 kg]

Mounting: Mounting ears provided for 19" (48 cm) or

23" (58 cm) racks

### ENVIRONMENT

• Temperature

Operating: 0°C to 50°C

Non-operating: -40°C to +75°C

• Humidity: 95%, non-condensing



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